

# M5K4164AL-12, -15

## 65 536-BIT (65 536-WORD BY 1-BIT) DYNAMIC RAM

#### DESCRIPTION

This is a family of 65 536-word by 1-bit dynamic RAMs, fabricated with the high performance N-channel silicongate MOS process, and is ideal for large-capacity memory systems where high speed, low power dissipation, and low costs are essential. The use of double-layer polysilicon process technology and a single-transistor dynamic storage cell privide high circuit density at reduced costs, and the use of dynamic circuitry including sense amplifiers assures low power dissipation. Multiplexed address inputs permit both a reduction in pins to the 16-pin zigzag inline package configuration and an increase in system densities. The M5K4164AL operates on a 5V power supply using the on-chip substrate bias generator.

#### **FEATURES**

#### High speed

Typė name	Access time (max) (ns)	Cycle time (min) (ns)	Power dissipation (typ) (mW)
M5K4164AL-12	120	220	175
M5K4164AL-15	150	260	150

- 16 pin zigzag inline package
- Single 5V±10% supply
- Low standby power dissipation: 22mW (max)
- Low operating power dissipation:

M5K4164AL-12 275mW (max) M5K4164AL-15 250mW (max)

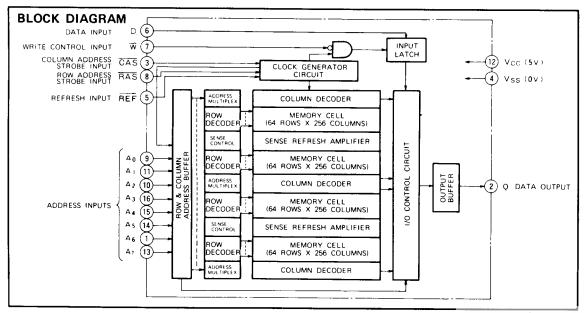
- Unlatched output enables two-dimensional chip selection and extended page boundary
- Early-write operation gives common I/O capability
- Read-modify-write, RAS-only refresh, and page-mode capabilities

#### PIN CONFIGURATION (TOP VIEW) ADDRESS INPUT DATA OUTPUT COLUMN ADDRESS STROBE INPUT Vss (OV) REFRESH INPUT [6] ← D DATA INPUT WRITE CONTROL Ž. 64 RAS ROW ADDRESS 8 10 $A_2$ ADDRESS INPUT [i] N ADDRESS Voc (5 V) INPUTS → [3] 등 A5 ) ADDRES\$ **→** [15] INPUTS **Outline 16P5A**

- All input terminals have low input capaciatance and are directly TTL-compatible
- Output is three-state and directly TTL-compatible
- 128 refresh cycles every 2ms
   (16K dynamic RAMs M5K4116P, S compatible)
- CAS controlled output allows hidden refresh
- Output data can be held infinitely by CAS

#### **APPLICATION**

- Main memory unit for computers
- Refresh memory for CRT







#### **FUNCTION**

The M5K4164AL provides, in addition to normal read, write, and read-modify-write operations, a number of other functions, e.g., page mode, RAS-only refresh, and delayed-write. The input conditions for each are shown in Table 1.

Table 1 Input conditions for each mode ->

				inputs				Output		
Operation	RAS	CAS	w	D	Row address	Column address	REF	o	Refresh	Remarks
Read	ACT	ACT	NAC	DNC	APD	APD	NAC	VLD	YES	
Write (Early write)	ACT	ACT	ACT	VLD	APD	APD	NAC	OPN	YES	Page mode identical.
Read-modify-write	ACT	ACT	ACT	VLD	APD	APD	NAC	VLD	YES	
RAS-only refresh	ACT	NAC	DNC	DNC	APD	DNC	NAC	OPN	YES	
Hidden refresh	ACT	ACT	DNC	DNC	APD	DNC	NAC	VLD	YES	
Automatic refresh	NAC	DNC	DNC	DNC	DNC	DNC	ACT	OPN	YES	
Self refresh	NAC	DNC	DNC	DNC	DNC	DNC	ACT	OPN	YES	
Hidden automatic refresh	NAC	ACT	DNC	DNC	DNC	DNC	ACT	VLD	YES	
Hidden self refresh	NAC	ACT	DNC	DNC	DNC	DNC	ACT	VLD	YES	
Standby	NAC	DNC	DNC	DNC	DNC	DNC	NAC	OPN	NO	

Note: ACT : active, NAC : nonactive, DNC : don't care, VLD : valid, APD : applied, OPN : open

# SUMMARY OF OPERATIONS

## Addressing

To select one of the 65 536 memory cells in the M5K4164AL the 16-bit address signal must be multiplexed into 8 address signals, which are then latched into the on-chip latch by two externally-applied clock pulses. First, the negative-going edge of the row-address-strobe pulse (RAS) latches the 8 row-address bits; next, the negative-going edge of the column-address-strobe pulse (CAS) latches the 8 column-address bits. Timing of the RAS and CAS clocks can be selected by either of the following two methods:

- The delay time from RAS to CAS t<sub>d(RAS-CAS)</sub> is set between the minimum and maximum values of the limits. In this case, the internal CAS control signals are inhibited almost until t<sub>d(RAS-CAS)max</sub> ('gated CAS' operation). The external CAS signal can be applied with a margin not affecting the on-chip circuit operations, e.g. access time, and the address inputs can be easily changed from row address to column address.
- The delay time t<sub>d(RAS-CAS)</sub> is set larger than the maximum value of the limits. In this case the internal inhibition of CAS has already been released, so that the internal CAS control signals are controlled by the externally applied CAS, which also controls the access time.

## Data Input

Date to be written into a selected cell is strobed by the later of the two negative transitions of  $\overline{W}$  input and  $\overline{CAS}$  input. Thus when the  $\overline{W}$  input makes its negative transition prior to  $\overline{CAS}$  input (early write), the data input is strobed by  $\overline{CAS}$ , and the negative transition of  $\overline{CAS}$  is set as the reference point for set-up and hold times. In the read-write

or read-modify-write cycles, however, when the  $\overline{W}$  input makes its negative transition after  $\overline{CAS}$ , the  $\overline{W}$  negative transition is set as the reference point for setup and hold times.

### **Data Output Control**

The output of the M5K4164AL is in the high-impedance state when  $\overline{CAS}$  is high. When the memory cycle in progress is a read, read-modify-write, or a delayed-write cycle, the data output will go from the high-impedance state to the active condition, and the data in the selected cell will be read. This data output will have the same polarity as the input data. Once the output has entered the active condition, this condition will be maintained until  $\overline{CAS}$  goes high, irrespective of the condition of  $\overline{RAS}$ .

The output will remain in the high-impedance state throughout the entire cycle in an early-write cycle.

These output conditions, of the M5K4164AL, which can readily be changed by controlling the timing of the write pulse in a write cycle, and the width of the CAS pulse in a read cycle, offer capabilities for a number of applications, as follows.

#### 1. Common I/O Operation

If all write operations are performed in the early-write mode, input and output can be connected directly to give a common I/O data bus.

#### 2. Data Output Hold

The data output can be held between read cycles, without lengthening the cycle time. This enables extremely flexible clock-timing settings for  $\overline{RAS}$  and  $\overline{CAS}$ .



#### 3. Two Methods of Chip Selection

Since the output is not latched,  $\overline{CAS}$  is not required to keep the outputs of selected chips in the matrix in a high-impedance state. This means that  $\overline{CAS}$  and/or  $\overline{RAS}$  can both be decoded for chip selection.

#### 4. Extended-Page Boundary

By decoding  $\overline{\text{CAS}}$ , the page boundary can be extended beyond the 256 column locations in a single chip. In this case,  $\overline{\text{RAS}}$  must be applied to all devices.

#### Page-Mode Operation.

This operation allows for multiple-column addressing at the same row address, and eliminates the power dissipation associated with the negative-going edge of RAS, because once the row address has been strobed, RAS is maintained. Also, the time required to strobe in the row address for the second and subsequent cycles is eliminated, thereby decreasing the access and cycle times.

#### Refresh

Each of the 128 rows ( $A_0 \sim A_6$ ) of the M5K4164AL must be refreshed every 2 ms to maintain data. The methods of refreshing for the M5K4164AL are as follows.

#### 1. Normal Refresh

Read cycle and Write cycle (early write, delayed write or read-modify-write) refresh the selected row as defined by the low order (RAS) addresses. Any write cycle, of course, may change the state of the selected cell. Using a read, write, or read-modify-write cycle for refresh is not recommended for systems which utilize "wire-OR" outputs since output bus contention will occur.

#### 2. RAS Only Refresh

A RAS-only refresh cycle is the recommended technique for most applications to provide for data retention. A RAS-only refresh cycle maintains the output in the high-impedance state with a typical power reduction of 20% over a read or write cycle.

#### 3. Automatic Refresh

Pin 5 (REF) has two special functions. The M5K416AL has a refresh address counter, refresh address multiplexer and refresh timer for these operations. Automatic refresh is initiated by bringing REF low after RAS has precharged and is used during standard operation just like RAS-only refresh, except that sequential row addresses from an external counter are no longer necessary.

At the end of automatic refresh cycle, the internal refresh address counter will be automatically incremented. The output state of the refresh address counter is initiated by some eight REF, RAS or RAS/CAS cycle after power is applied. Therefore, a special operation is not necessary to initiate it.

RAS must remain inactive during REF activated cycles. Likewise, REF must remain inactive during RAS generated cycle.

#### 4. Self-Refresh

The other function of pin 5 (REF) is self-refresh. Timing for self-refresh is quite similar to that for automatic refresh. As long as RAS remains high and REF remains low, the M5K4164AL will refresh itself. This internal sequence repeats asynchronously every 12 to 16  $\mu$ s. After 2 ms, the onchip refresh address counter has advanced through all the row addresses and refreshed the entire memory. Self-refresh is primarily intended for trouble free power-down operation.

For example, when battery backup is used to maintained data integrity in the memory. REF may be used to place the device in the self-refresh mode with no external timing signals necessary to keep the information alive.

In summary, the pin 5 (REF) refresh function gives the user a feature that is free, save him hardware on the board, and in fact, will simplify his battery backup procedures, increase his battery life, and save him overall cost while giving him improved system performance.

There is an internal pullup resister ( $\approx$  3M $\Omega$ ) on pin 5, so if the pin 5 (REF) function is not used, pin 5 may be left open (not connect) without affecting the normal operations.

#### 5. Hidden Refresh

A feature of the M5K4164AL is that refresh cycles may be performed while maintaining valid data at the output pin by extending the CAS active time from a previous memory read cycle. This feature is referred to as hidden refresh.

Hidden refresh is performed by holding  $\overline{CAS}$  at  $V_{IL}$  and taking  $\overline{RAS}$  high and after a specified precharge period, executing a  $\overline{RAS}$ -only cycling, automatic refresh and self-refresh, but with  $\overline{CAS}$  held low.

The advantage of this refresh mode is that data can be held valid at the output data port indefinitely by leaving the  $\overline{\text{CAS}}$  asserted. In many applications this eliminates the need for off-chip latches.

#### **Power Dissipation**

Most of the circuitry in the M5K4164AL is dynamic, and most of the power is dissipated when addresses are strobed. Both  $\overline{RAS}$  and  $\overline{CAS}$  are decoded and applied to the M5K4164AL as chip-select in the memory system, but if  $\overline{RAS}$  is decoded, all unselected devices go into stand-by independent of the  $\overline{CAS}$  condition, minimizing system power dissipation.

#### Power Supplies

The M5K4164AL operates on a single 5V power supply.

A wait of some 500µs and eight or more dummy cycle is necessary after power is applied to the device before memory operation is achieved.



## ABSOLUTE MAXIMUM RATINGS

Symbol	Paramater	Conditions	Limits	Unit
Vcc	Supply voltage		-1-7	V
Vı	Input voltage	With respect to V <sub>SS</sub>	-1-7	· v
Vo	Output voltage		- 1 ~ 7	V
10	Output current		50	mA
Pd	Power dissipation	Ta = 25°C	700	mW
Topr	Operating free-air temperature range		1 0~70	·c
Tstg	Storage temperature range		<b>−65 ~ 150</b>	·c

## RECOMMENDED OPERATING CONDITIONS (Ta = 0 ~ 70°C, unless otherwise noted) (Note 1)

	Symbol	Parameter	Limits				
Į	[ Symbol	rarameter	Min	Nom	Max	Unit	
S	ievccU.coi	□ Supply voltage	4.5	5	5.5	V	
	Vss	Supply voltage	0	0	0	٧	
	V <sub>IH</sub>	High-level input voltage, all inputs	2.4		6.5	٧	
1	VIL	Low-level input voltage, all inputs	-2		0.8	٧	

Note 1 All voltage values are with respect to VSS

## **ELECTRICAL CHARACTERISTICS** (Ta = $0 \sim 70^{\circ}$ C, $V_{CC} = 5V \pm 10\%$ , $V_{SS} = 0V$ , unless otherwise noted) (Note 2)

Symbol	Parameter	i	Test conditions		Limits		
Symbol	Parameter		lest conditions	Min	Тур	Max	Unit
Vон	High-level output voltage		$I_{OH} = -5mA$	2.4		Vcc	V
VOL	Low-level output voltage		I <sub>OL</sub> = 4.2 mA	0		0.4	V
loz	Off-state output current		Q floating 0V ≤V <sub>OUT</sub> ≤5.5V	<b>— 10</b>	<del>-</del>	10	μА
11	Input current		$0V \le V_{IN} \le 6.5V$ , All other pins = $0V$	- 10		10	μА
laa.c	Average supply current from V <sub>CC</sub> ,	M5K4164AL-12	RAS, CAS cycling			50	mA
CC1(AV)	operating (Note 3, 4)	M5K4164AL-15	$t_{ extsf{CR}}\!=\!t_{ extsf{CW}}\!=\!$ min output open			45	mA
I <sub>CC2</sub>	Supply current from V <sub>CC</sub> , standby		RAS = VIH output open			4	mA
1	Average supply current from V <sub>CC</sub> ,	M5K4164AL-12	RAS cycling CAS = VIH	T		40	mA
CC3(AV)	refreshing (Note 3)	M5K4164AL-15	to(REF) = min, output open			35	mA
	Average supply current from V <sub>CC</sub> ,	M5K4164AL-12	RAS = VIL, CAS cycling			40	mA
CC4(AV)	page mode (Note 3, 4)	M5K4164AL-15	t CPG = min. output open			35	mA
1	Average supply current from V <sub>CC</sub> ,	M5K4164AL-12	RAS=VIH. REF cycling			40	mA
CC5(AV)	automatic refreshing (Note 3)	M5K4164AL-15	t <sub>C</sub> (REF)=min , output open			35	mA
ICC6(AV)	Average supply current from V <sub>CC</sub> , se	elf refreshing	$\overline{RAS} = V_{IH}$ , $\overline{REF} = V_{IL}$			. 8	mA
C <sub>I</sub> (A)	Input capacitance, address inputs					5	pF
C <sub>1 (D)</sub>	Input capacitance, data input		$V_1 = V_{SS}$			5	ρF
C <sub>1</sub> (w)	Input capacitance, write control inpu	t	f=1MHz			7	pF
Ci (RAS)	Input capacitance, RAS input		$V_i = 25 \text{mVrms}$			10	pF
C+(CAS)	Input capacitance, CAS input					10	pF
C <sub>I(REF)</sub>	Input capacitance, REF input					10	pF
Co	Output capacitance		$V_0 = V_{SS}$ , $f = 1MHz$ , $V_1 = 25mVrms$	1 1		7	pF

Note 2. Current flowing into an IC is positive, out is negative.

- 3 TCC1(AV), TCC3(AV), TCC4(AV) and TCC5(AV) are dependent on cycle rate. Maximum current is measured at the fastest cycle rate.
- 4 TCC1(AV) and TCC4(AV) are dependent on output loading. Specified values are obtained with the output open.

### TIMING REQUIREMENTS (For Read, Write, Read-Modify-Write, Refresh, and Page-Mode Cycle)

(  $Ta = 0 \sim 70$ °C ,  $V_{CC} = 5V \pm 10\%$ ,  $V_{SS} = 0V$ , unless otherwise noted, See notes 5, 6 and 7 )

			A1	M5K41	64AL-12	M5K41	64AL-15	
Symbol	Parameter		Alternative Symbol	Lir	mits	L	mits	Unit
			Symbol	Min	Max	Min	Max	
tone	Refresh cycle time		t <sub>REF</sub>		2		2	ms
tw(RASH)	RAS high pulse width		t <sub>RP</sub>	90		100		ns
tw(RASL)	RAS low pulse width		t <sub>ras</sub>	120	10000	150	10000	ns
tw(CASL)	CAS low pulse width	,	tcas	60	∞	75	∞	ns
tw(CASH)	CAS high pulse width	(Note 8)	t <sub>CPN</sub>	30		35		. ns
th(HAS-CAS)	CAS hold time after RAS		t <sub>CSH</sub>	120		150		ns
th(CAS-RAS)	RAS hold time after CAS		t <sub>RSH</sub>	60		75		ns
td(CAS-RAS)	Delay time, CAS to RAS	(Note 9)	tore	- 20		-20		ns
BB (RAS CAS)OF	Delay time, RAS to CAS	(Note 10)	t <sub>RCD</sub>	25	60	30	75	ns
t su (RA-RAS)	Row address setup time before RAS		t ASR	0		0		ns
t su (CA-CAS)	Column address setup time before CAS		t ASC	0		0		ns
th(RAS-RA)	Row address hold time after RAS		t <sub>RAH</sub>	15		20		ns
tn(CAS-CA)	Column address hold time after CAS		t <sub>CAH</sub>	20		25		ns
th(RAS-CA)	Column address hold time after RAS		t AR	90		95		ns
t <sub>THL</sub> t <sub>TLH</sub>	Transition time		t <sub>T</sub>	3	35	3	50	ns

Note: 5 An initial pause of 500µs is required after power-up followed by any eight REF, RAS or RAS/CAS cycles before proper device operation is achieved.

- 6 The switching characteristics are defined as  $t_{THL} = t_{TLH} = 5 \text{ns}$
- Reference levels of input signals are VIH min, and VIL max. Reference levels for transition time are also between VIH and VIL.
- td(CAS.RAS) requirement is only applicable for RAS/CAS cycles preceded by a CAS only cycle (i.e., For systems where CAS has not been decoded with RAS)
- Operation within the td (RAS-CAS) max limit insures that ta (RAS) max can be met. td (RAS-CAS) max is specified reference point only, if td (RAS-CAS) is greater than the specified td (RAS-CAS) max limit, then access time is controlled exclusively by ta(CAS).

## SWITCHING CHARACTERISTICS (Ta = 0 ~ 70°C, VCC = 5V ± 10%, VSS = 0V, unless otherwise noted) **Read Cycle**

			Alternative	M5K416	64AL-12	M5K41	54AL-15	
Symbol	Parameter		Symbol	Lin	nits	Lin	nits	Unit
			Symbol	Min	Max	Min	Max	
tcR	Read cycle time		t <sub>RC</sub>	220		260		ns
tsu (R-CAS)	Read setup time before CAS		t <sub>RCS</sub>	0		0		ns
th (CASER)	Read hold time after CAS	(Note 11)	t <sub>RCH</sub>	0		0		ns
th(RAS-R)	Read hold time after RAS	(Note 11)	t AAH	10	-	20		ns
tdis(CAS)	Output disable time	(Note 12)	toff	0	35	0	40	ns
ta (CAS)	CAS access time	(Note 13)	t CAC		60		75	ns
ta (RAS)	RAS access time	(Note 14)	t RAC		120		150	ns

- Either  $th_{(RAS-R)}$  or  $th_{(CAS-R)}$  must be satisfied for a read cycle. Note 11
- Note 12: Idis (CAS) max defines the time at which the output achieves the open circuit condition and is not reference to VOH or VOL Note 13.
- This is the value when 'td (RAS-CAS)≥td (RAS-CAS)max. Test conditions: Load = 2T TL, C<sub>L</sub> = 100pF

  This is the value when 'td (RAS-CAS)≥td (RAS-CAS)max. When td (RAS-CAS)max, ta (RAS-CAS)max, Note 14

## Write Cycle

		Alternative -	M5K41	54AL-12	M5K4164AL-15		_
Symbol	Parameter		Limits		Limits		Unit
			Min	Max	Min	Max	Ì
t <sub>cw</sub>	Write cycle time	t <sub>RC</sub>	220		260		ns
tsu(w-CAS)	Write setup time before CAS (Note 17)	twcs	<b>– 5</b>		- 5		ns
th (cas-w)	Write hold time after CAS	t worr	40		45		ns
th (RAS-W)	Write hold time after RAS	t wcn	90		95		ns
th (w-RAS)	RAS hold time after write	t <sub>RWL</sub>	40		45		ns
th(w-CAS)	CAS hold time after write	towL	40		45		ns
tw(w)	Write pulse width	t <sub>wP</sub>	40		45		ns
tsu (D-CAS)	Data-in setup time before CAS	t <sub>DS</sub>	0		0		ns
th (CAS-D)	Data-in hold time after CAS	t <sub>DH</sub>	40		45		ns
th (RAS-D)	Data-in hold time after RAS	t <sub>DHR</sub>	90		95		ns

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# Read-Write and Read-Modify-Write Cycles

			A4	M5K416	64AL-12	M5K416	64AL-15	_
Symbol	Parameter		Alternative -	Limits		Limits		Unit
		Min		Max	Min	Max	1	
tonw	Read-write cycle time	(Note 15)	tawc	245		280		ns
tcRMW	Read-modify-write cycle time	(Note 16)	t <sub>RMWC</sub>	265		310		ns
th (w-RAS)	RAS hold time after write	İ	tewL	40		45		ns
th (w-cas)	CAS hold time after write		towL	40		45		ns
tw(w)	Write pulse width		t <sub>wp</sub>	40		45		ns
tsu (R-CAS)	Read setup time before CAS		t RCS	0		0		ns
td (BAS-W)	Delay time, RAS to write	(Note 17)	t <sub>RWD</sub>	100		120		ns
td (CAS-W)	Delay time, CAS to write	(Note 17)	t <sub>CWD</sub>	40		60		ns
tsu(p-w)	Data-in setup time before write		t <sub>DS</sub>	0		0		ns
antw-prom	Data-in hold time after write		t <sub>DH</sub>	40		45		ns
tdis (CAS)	Output disable time		toff	0	35	0	40	ns
ta (CAS)	ČAS access time	(Note 13)	t CAC		60		75	пѕ
ta (RAS)	RAS access time	(Note 14)	t RAC		120		150	ns

Note 15:  $t_{\text{CRW}}$ min is defined as  $t_{\text{CRW}}$  min =  $t_{\text{d}}$  (RAS-W) +  $t_{\text{h}}$  (W-RAS) +  $t_{\text{w}}$  (RASH) +  $3t_{\text{TLH}}$  ( $t_{\text{THL}}$ )

- 16  $t_{CRMW}$  min is defined as  $t_{CRMW}$  min =  $t_{CRMW}$  min =  $t_{CRMW}$  min =  $t_{CRMW}$  min =  $t_{CRMW}$  min is defined as  $t_{CRMW}$  min =  $t_{CRMW}$  min is defined as  $t_{CRMW}$  min =  $t_{CRMW}$  min is defined as  $t_{CRMW}$  min =  $t_{C$
- 17 tsu (w-CAS), td (RAS-w), and td (CAS-w) do not define the limits of operation, but are included as electrical characteristics only.
  When tsu (w-CAS) ≥ tsu (w-CAS)min, an early-write cycle is performed, and the data output keeps the high-impedance state.
  When td (RAS-w) ≥ td (RAS-w)min, and td (CAS-w) ≥ tsu(w-CAS)min a read-write cycle is performed, and the data of the selected address will be read out on the data output.

For all conditions other than those described above, the condition of data output (at access time and until CAS goes back to VIH) is not defined.

#### Page-Mode Cycle

			M5K4164AL-12 Limits		M5K4164AL-15 Limits		Unit
Symbol	Parameter	Alternative - Symbol					
		Symbol	Min	Max	Min	Max	
t <sub>c PGB</sub>	Page-mode read cycle time	t <sub>PC</sub>	140		145		ns
t <sub>c PGW</sub>	Page-Mode write cycle time	t <sub>PC</sub>	140		145		ns
t <sub>c PGRW</sub>	Page Mode read-write cycle time	-	150		180		ns
t <sub>C</sub> PGRMW	Page-Mode read-modify-write cycle time		170		195		ns
tw(CASH)	CAS high pulse width	t <sub>CP</sub>	55		60		ns

#### **Automatic Refresh Cycle**

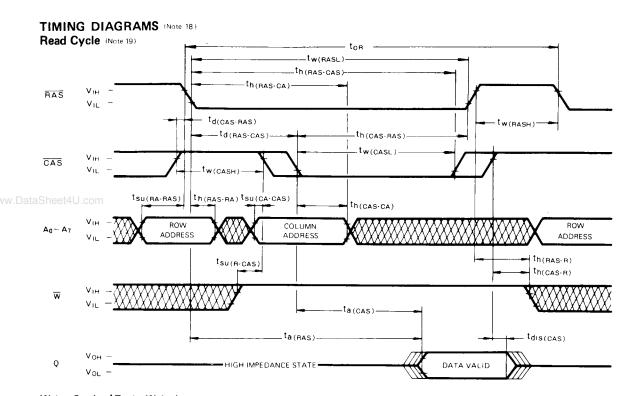
		Alternative	M5K41	64AL-12	M5K410	64AL-15	
Symbol	Parameter	Symbol	Limits		Limits		Unit
		Symbol	Min	Max	Min	Max	
tc (REF)	Automatic Refresh cycle time	t <sub>FC</sub>	220		260		ns
td (RAS-REF)	Delay time, RAS to REF	t <sub>RFD</sub>	90		100		ns
tw (REFL)	REF low pulse width	t <sub>FP</sub>	60	8000	60	8000	ns
tw (REFH)	REF high pulse width	t <sub>FI</sub>	30		30		ns
td (REF-RAS)	Delay time, REF to RAS	trsa	30		30		ns
tsu (AEF-RAS)	REF pulse setup time before RAS	t <sub>FRD</sub>	250		295	i	ns

## Self-Refresh Cycle

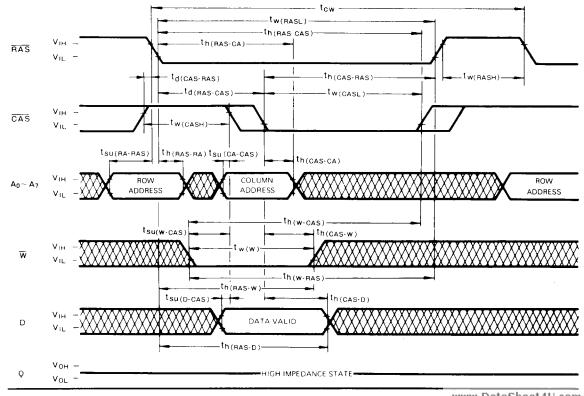
		Alternative	M5K4164AL-12 Limits		M5K4164AL-15 Limits		Unit
Symbol Paramet	Parameter	Symbol					
		Symbol	Min	Max	Min	Max	
td (RAS-REF)	Delay time, RAS to REF	t <sub>RFD</sub>	90		100		ns
tw(REFL)	REF low pulse width	t <sub>FBP</sub>	8000	8	8000	∞	ns
td (REF-RAS)	Delay time, REF to RAS	t <sub>FBR</sub>	250		295		ns

# M5K4164AL-12, -15

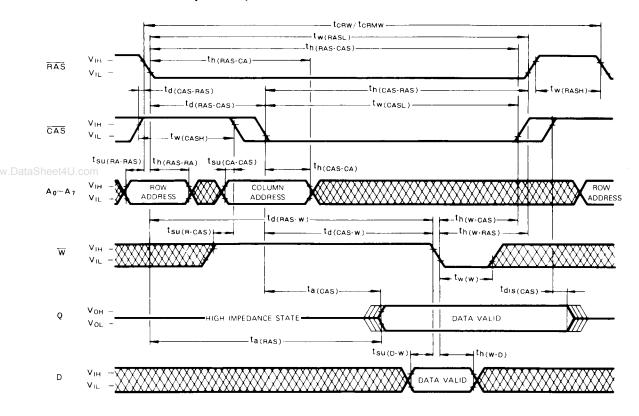
### 65 536-BIT (65 536-WORD BY 1-BIT) DYNAMIC RAM



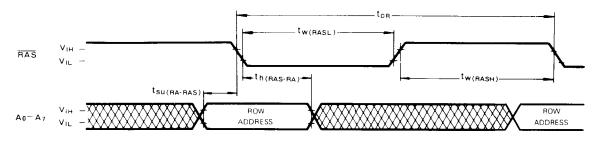
## Write Cycle (Early Write) (Note 19)



### Read-Write and Read-Modify-Write Cycles (Note 19)



## RAS-Only Refresh Cycle (Note 20)





Note 18

Indicates the don't care input

Note 19. REF VIH

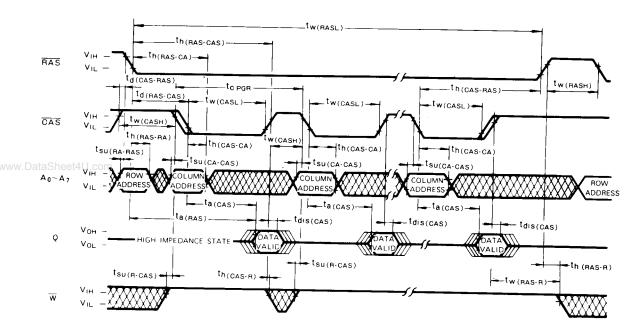
20.  $\widehat{CAS} = \widehat{REF} = V_{IH}$ ,  $\overline{W}$ , D = don't care. A7 may be  $V_{IH}$  or  $V_{IL}$ .

The center line indicates the high-impedance state

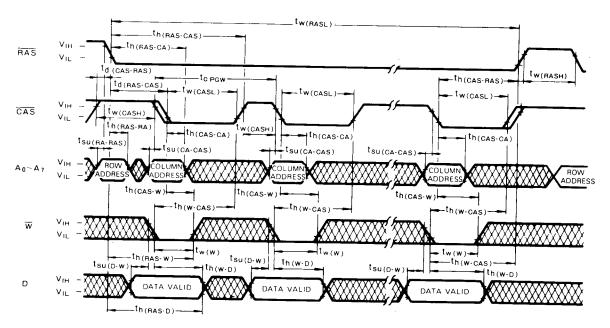
www.DataSheet4U.com



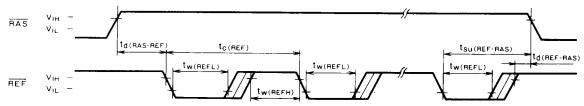
## Page-Mode Read Cycle (Note 19)



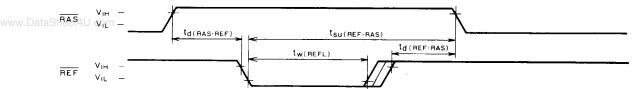
# Page-Mode Write Cycle (Note 19)



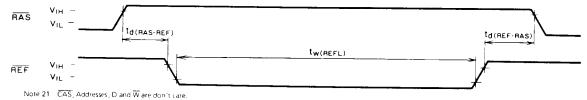
# Automatic Pulse Refresh Cycle (Multiple Pulse) (Note 21)



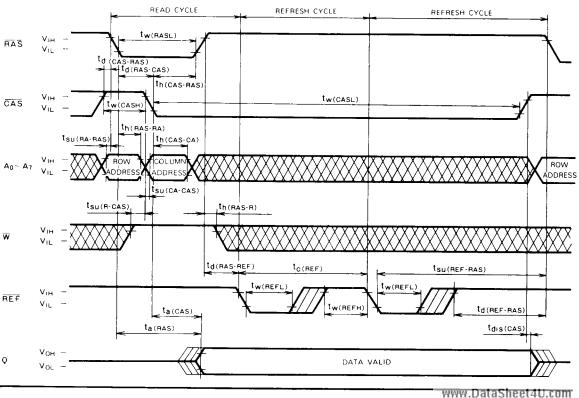
## Automatic Pulse Refresh Cycle (Single Pulse) (Note 21)



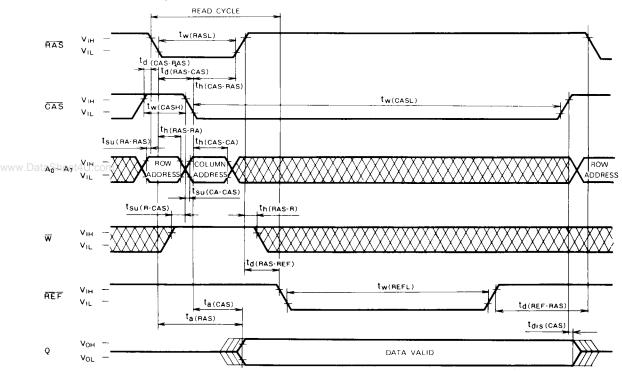
#### Self-Refresh Cycle (Note 21)



# Hidden Automatic Pulse Refresh Cycle



#### Hidden Self-Refresh Cycle



Note 22. If the pin 5 (REF) function is not used, pin 5 may be left open (not connect),

